Remote/Local Temperature Sensor with SMBus Serial Interface

General Description

The MAX1617A is a precise digital thermometer that reports the temperature of both a remote sensor and its own package. The remote sensor is a diode-connected transistor—typically a low-cost, easily mounted 2N3904 NPN type—that replaces conventional thermistors or thermocouples. Remote accuracy is ±3°C for multiple transistor manufacturers, with no calibration needed. The remote channel can also measure the die temperature of other ICs, such as microprocessors, that contain an on-chip, diode-connected transistor.

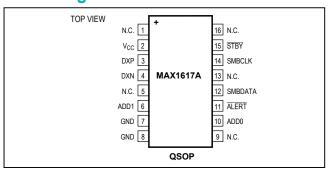
The 2-wire serial interface accepts standard System Management Bus (SMBus) Write Byte, Read Byte, Send Byte, and Receive Byte commands to program the alarm thresholds and to read temperature data. The data format is 7 bits plus sign, with each bit corresponding to 1°C, in two's complement format. Measurements can be done automatically and autonomously, with the conversion rate programmed by the user or programmed to operate in a single-shot mode. The adjustable rate allows the user to control the supply-current drain.

The MAX1617A is nearly identical to the popular MAX1617, but has improved SMBus timing specifications, improved bus collision immunity, software manufacturer and device identification available via the serial interface, and a power-on reset function that can force a reset of the slave address via the serial interface.

Applications

- Desktop and Notebook Computers
- Smart Battery Packs
- LAN Servers
- Industrial Controls
- Central Office
 Telecom Equipment
- Test and Measurement
- Multichip Modules

Pin Configuration



Features

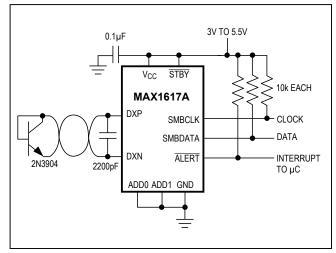
- Two Channels: Measures Both Remote and Local Temperatures
- No Calibration Required
- SMBus 2-Wire Serial Interface
- Programmable Under/Overtemperature Alarms
- Supports SMBus Alert Response
- Supports Manufacturer and Device ID Codes
- Accuracy
 - ±2°C (+60°C to +100°C, local)
 - ±3°C (-40°C to +125°C, local)
 - ±3°C (+60°C to +100°C, remote)
- 3μA (typ) Standby Supply Current
- 70µA (max) Supply Current in Auto-Convert Mode
- +3V to +5.5V Supply Range
- Small 16-Pin QSOP Package

Ordering Information

PART	PIN-PACKAGE	PIN-PACKAGE
MAX1617AMEE+	-55°C to +125°C	16 QSOP

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

Typical Operating Circuit





Remote/Local Temperature Sensor with SMBus Serial Interface

Absolute Maximum Ratings

V _{CC} to GND0.3V to +6V DXP, ADD_ to GND0.3V to (V _{CC} + 0.3V) DXN to GND0.3V to +0.8V	Continuous Power Dissipation (T _A = +70°C) QSOP (derate 8.30mW/°C above +70°C)667mW Operating Temperature Range55°C to +125°C
SMBCLK, SMBDATA, ALERT, STBY to GND0.3V to +6V	Junction Temperature+150°C
SMBDATA, ALERT Current1mA to +50mA	Storage Temperature Range65°C to +165°C
DXN Current±1mA	Lead Temperature (soldering, 10sec)+300°C
ESD Protection (SMBCLK, SMBDATA,	Soldering Temperature (reflow)+260°C
ALERT, Human Body Model)4000V	
ESD Protection (other pins, Human Body Model)2000V	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

 $(V_{CC} = +3.3V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}) \text{ (Note 1)}$

PARAMETER	CONDI	MIN	TYP	MAX	UNITS	
ADC AND POWER SUPPLY						
Temperature Resolution (Note 2)	Monotonicity guaranteed		8			Bits
Initial Temperature Error,	T _A = +60°C to +100°C	-2		2	°C	
Local Diode (Note 3)	$T_A = 0$ °C to +85°C		-3		3	
Temperature Error, Remote Diode	$T_R = +60^{\circ}C \text{ to } +100^{\circ}C$		-3		3	°C
(Notes 3 and 4)	$T_R = -55^{\circ}C \text{ to } +125^{\circ}C$		-5		5	
Temperature Error, Local Diode	Including long-term drift	$T_A = +60^{\circ}C \text{ to } +100^{\circ}C$	-2.5		2.5	°C
(Notes 2 and 3)	moldaling long-term and	$T_A = 0$ °C to +85°C	-3.5		3.5	
Supply-Voltage Range			3.0		5.5	V
Undervoltage Lockout Threshold	V _{CC} input, disables A/D co	nversion, rising edge	2.60	2.80	2.95	V
Undervoltage Lockout Hysteresis				50		mV
Power-On Reset Threshold	V _{CC} , falling edge		1.0	1.7	2.5	V
POR Threshold Hysteresis				50		mV
		SMBus static		3	10	
Standby Supply Current	Logic inputs forced to V _{CC} or GND	Hardware or software standby, SMBCLK at 10kHz		4		μA
Average Operating Supply Current	Auto-convert mode, average measured over	0.25 conv/sec		35	70	μA
Average Operating Supply Current	4sec. Logic inputs forced to V _{CC} or GND.	2.0 conv/sec		120	180	μΑ
Conversion Time	From stop bit to conversion (both channels)	complete	94	125	156	ms
Conversion Rate Timing Error	Auto-convert mode		-25		25	%
Damata Diada Caura Current	DVD formed to 4.5V	High level	80	100	120	
Remote-Diode Source Current	DXP forced to 1.5V	Low level	8	10	12	μA
DXN Source Voltage		•		0.7		V
Address Pin Bias Current	ADD0, ADD1; momentary u	ipon power-on reset		160		μA

Electrical Characteristics (continued)

 $(V_{CC} = +3.3V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}) \text{ (Note 1)}$

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SMBus INTERFACE					
Logic Input High Voltage	STBY, SMBCLK, SMBDATA; V _{CC} = 3V to 5.5V	2.2			V
Logic Input Low Voltage	$\overline{\text{STBY}}$, SMBCLK, SMBDATA; V _{CC} = 3V to 5.5V			0.8	V
Logic Output Low Sink Current	ALERT, SMBDATA forced to 0.4V	6			mA
ALERT Output High Leakage Current	ALERT forced to 5.5V			1	μA
Logic Input Current	Logic inputs forced to V _{CC} or GND	-1		1	μA
SMBus Input Capacitance	SMBCLK, SMBDATA		5		pF
SMBus Clock Frequency	(Note 5)	DC		100	kHz
SMBCLK Clock Low Time	t _{LOW} , 10% to 10% points	4.7			μs
SMBCLK Clock High Time	t _{HIGH} , 90% to 90% points	4			μs
SMBus Start-Condition Setup Time		4.7			μs
SMBus Repeated Start-Condition Setup Time	t _{SU:STA} , 90% to 90% points	500			ns
SMBus Start-Condition Hold Time	t _{HD:STA} , 10% of SMBDATA to 90% of SMBCLK	4			μs
SMBus Stop-Condition Setup Time	t _{SU:STO} , 90% of SMBCLK to 10% of SMBDATA	4			μs
SMBus Data Valid to SMBCLK Rising-Edge Time	t _{SU:DAT} , 10% or 90% of SMBDATA to 10% of SMBCLK	250			ns
SMBus Data-Hold Time	t _{HD:DAT} (Note 6)	0			μs
SMBCLK Falling Edge to SMBus Data-Valid Time	Master clocking in data			1	μs

Electrical Characteristics

(V_{CC} = +3.3V, T_A = -55 $^{\circ}$ C to +125 $^{\circ}$ C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
ADC AND POWER SUPPLY					
Temperature Resolution (Note 2)	Monotonicity guaranteed				Bits
Initial Temperature Error,	T _A = +60°C to +100°C	-2		2	°C
Local Diode (Note 3)	T _A = -55°C to +125°C	-3		3	
Temperature Error, Remote Diode	T _R = +60°C to +100°C	-3	-	3	°C
(Notes 3 and 4)	T _R = -55°C to +125°C	-5		5	
Supply-Voltage Range		3.0		5.5	V
Conversion Time	From stop bit to conversion complete (both channels)		125	156	ms
Conversion Rate Timing Error	Auto-convert mode	-25		25	%

Electrical Characteristics (continued)

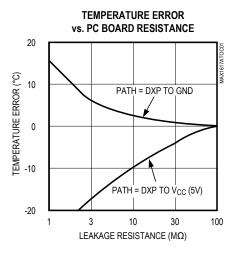
 $(V_{CC} = +3.3V, T_A = -55^{\circ}C \text{ to } +125^{\circ}C, \text{ unless otherwise noted.})$ (Note 1)

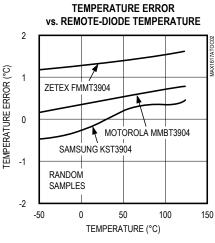
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
SMBus INTERFACE						
Logic Input High Voltage	CTDV CMDCLIC CMDDATA	V _{CC} = 3V	2.2			V
Logic Input High Voltage	STBY, SMBCLK, SMBDATA	V _{CC} = 5.5V	2.4			V
Logic Input Low Voltage	STBY, SMBCLK, SMBDATA; VC	C = 3V to 5.5V			0.8	V
Logic Output Low Sink Current	ALERT, SMBDATA forced to 0.4	ALERT, SMBDATA forced to 0.4V				mA
ALERT Output High Leakage Current	ALERT forced to 5.5V			1	μA	
Logic Input Current	Logic inputs forced to V _{CC} or GN	ID	-2		2	μA

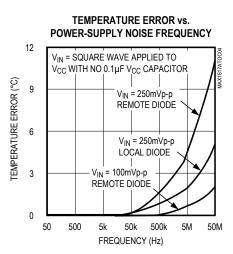
- Note 1: All devices 100% production tested at $T_A = +85^{\circ}C$. Limits over temperature are guaranteed by design.
- Note 2: Guaranteed but not 100% tested.
- Note 3: Quantization error is not included in specifications for temperature accuracy. For example, if the MAX1617A device temperature is exactly +66.7°C, the ADC may report +66°C, +67°C, or +68°C (due to the quantization error plus the +1/2°C offset used for rounding up) and still be within the guaranteed ±1°C error limits for the +60°C to +100°C temperature range (Table 2).
- Note 4: A remote diode is any diode-connected transistor from Table 1. TR is the junction temperature of the remote diode. See Remote-Diode Selection for remote diode forward voltage requirements.
- Note 5: The SMBus logic block is a static design that works with clock frequencies down to DC. While slow operation is possible, it violates the 10kHz minimum clock frequency and SMBus specifications, and may monopolize the bus.
- Note 6: Note that a transition must internally provide at least a hold time in order to bridge the undefined region (300ns max) of SMBCLK's falling edge.

Typical Operating Characteristics

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

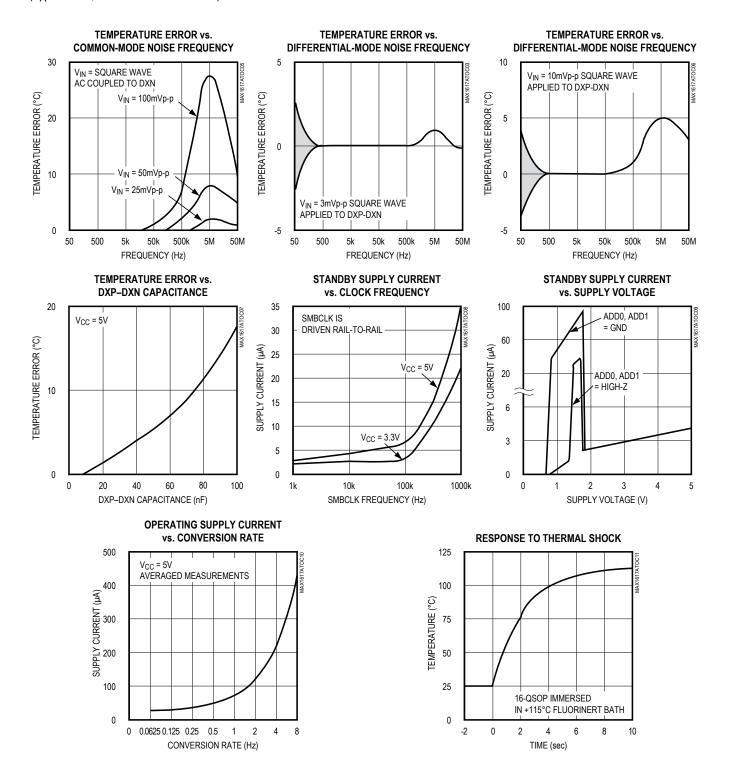






Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



Pin Description

PIN	NAME	FUNCTION
1, 5, 9, 13, 16	N.C.	No Connection. Not internally connected. May be used for PC board trace routing.
2	V _{CC}	Supply Voltage Input, 3V to 5.5V. Bypass to GND with a 0.1µF capacitor.
3	DXP	Combined Current Source and A/D Positive Input for Remote-Diode Channel. Do not leave DXP unconnected; tie DXP to DXN if no remote diode is used. Place a 2200pF capacitor between DXP and DXN for noise filtering.
4	DXN	Combined Current Sink and A/D Negative Input. DXN is normally biased to a diode voltage above ground.
6	ADD1	SMBus Address Select Pin (Table 8). ADD0 and ADD1 are sampled upon power-up. Excess capacitance (>50pF) at the address pins when unconnected may cause address-recognition problems.
7, 8	GND	Ground
10	ADD0	SMBus Slave Address Select Pin
11	ALERT	SMBus Alert (interrupt) Output, Open Drain
12	SMBDATA	SMBus Serial-Data Input/Output, Open Drain
14	SMBCLK	SMBus Serial-Clock Input
15	STBY	Hardware Standby Input. Temperature and comparison threshold data are retained in standby mode. Low = standby mode, high = operate mode.

General Description

The MAX1617A is a temperature sensor designed to work in conjunction with an external microcontroller (μ C) or other intelligence in thermostatic, process-control, or monitoring applications. The μ C is typically a power-management or keyboard controller, generating SMBus serial commands by "bit-banging" general-purpose input/output (GPIO) pins or via a dedicated SMBus interface block.

Essentially an 8-bit serial analog-to-digital converter (ADC) with a sophisticated front end, the MAX1617A contains a switched current source, a multiplexer, an ADC, an SMBus interface, and associated control logic (Figure 1). Temperature data from the ADC is loaded into two data registers, where it is automatically compared with data previously stored in four over/under-temperature alarm registers.

ADC and Multiplexer

The ADC is an averaging type that integrates over a 60ms period (each channel, typical) with excellent noise rejection.

The multiplexer automatically steers bias currents through the remote and local diodes, measures their forward voltages, and computes their temperatures. Both channels are automatically converted once the conversion process has started, either in free-running or single-shot mode. If one of the two channels is not used, the device still performs both measurements, and the user can simply ignore the results of the unused channel. If the remote diode channel is unused, tie DXP to DXN rather than leaving the pins open.

The DXN input is biased at 0.65V(typ) above ground by an internal diode to set up the analog-to-digital (A/D) inputs for a differential measurement. The typical DXP–DXN differential input voltage range is 0.25V to 0.95V. To ensure proper operation over full temperature range, ensure $V_{DXP} \leq (0.78 \text{ x V}_{CC} - 1.1)$ volts.

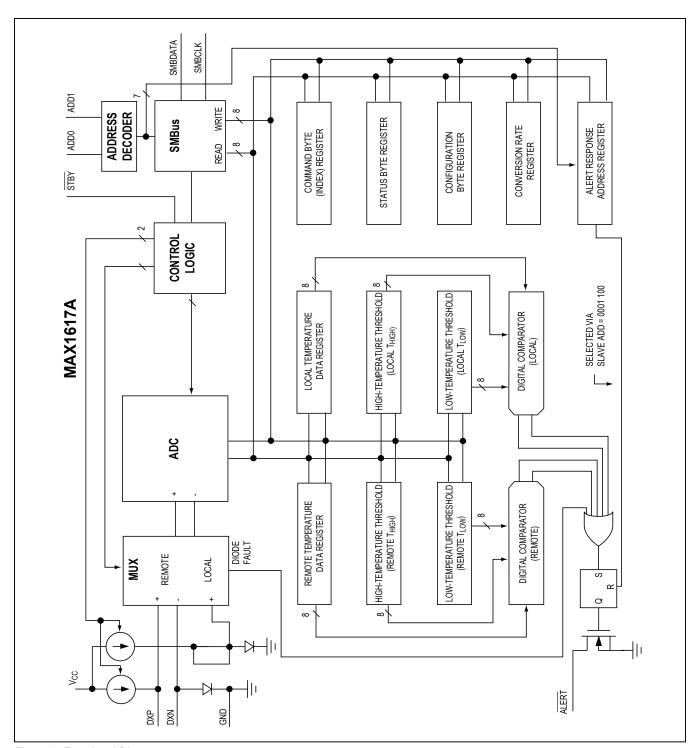


Figure 1. Functional Diagram

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Excess resistance in series with the remote diode causes about +1/2°C error per ohm. Likewise, 200µV of offset voltage forced on DXP–DXN causes about 1°C error.

A/D Conversion Sequence

If a Start command is written (or generated automatically in the free-running auto-convert mode), both channels are converted, and the results of both measurements are available after the end of conversion. A BUSY status bit in the status byte shows that the device is actually performing a new conversion; however, even if the ADC is busy, the results of the previous conversion are always available.

Remote-Diode Selection

Temperature accuracy depends on having a good-quality, diode-connected small-signal transistor. See <u>Table 1</u> for a recommended list of diode-connected small-signal transistors. The MAX1617A can also directly measure the die temperature of CPUs and other integrated circuits having on-board temperature-sensing diodes.

The transistor must be a small-signal type with a relatively high forward voltage; otherwise, the A/D input voltage range can be violated. The forward voltage must be greater than 0.25V at 10µA; check to ensure this is true at the highest expected temperature. The forward voltage (VDXP - VDXN) must be less than 0.95V at 100µA; additionally, ensure the maximum VDXP (DXP voltage) \leq (0.78 x VCC - 1.1) volts over your expected range of temperature. Large power transistors don't work at all. Also ensure that the base resistance is less than 100Ω. Tight specifications for forward-current gain (+50 to +150, for example) indicate that the manufacturer has good process controls and that the devices have consistent VBE characteristics.

For heatsink mounting, the 500-32BT02-000 thermal sensor from Fenwal Electronics is a good choice. This device consists of a diode-connected transistor, an aluminum plate with screw hole, and twisted-pair cable (Fenwal Inc., Milford, MA, 508-478-6000).

Thermal Mass and Self-Heating

Thermal mass can seriously degrade the MAX1617A's effective accuracy. The thermal time constant of the QSOP-16 package is about 140sec in still air. For the MAX1617A junction temperature to settle to within +1°C after a sudden +100°C change requires about five time constants or 12 minutes. The use of smaller packages for remote sensors, such as SOT23s, improves the situation. Take care to account for thermal gradients between the heat source and the sensor, and ensure that stray air currents across the sensor package do not interfere with measurement accuracy.

Table 1. Remote-Sensor Transistor Manufacturers

MANUFACTURER	MODEL NUMBER
Central Semiconductor (USA)	CMPT3904
Motorola (USA)	MMBT3904
National Semiconductor (USA)	MMBT3904
Rohm Semiconductor (Japan)	SST3904
Samsung (Korea)	KST3904-TF
Siemens (Germany)	SMBT3904
Zetex (England)	FMMT3904CT-ND

Note: Transistors must be diode-connected (base shorted to collector).

Self-heating does not significantly affect measurement accuracy. Remote-sensor self-heating due to the diode current source is negligible. For the local diode, the worst-case error occurs when auto-converting at the fastest rate and simultaneously sinking maximum current at the $\overline{\text{ALERT}}$ output. For example, at an 8Hz rate and with $\overline{\text{ALERT}}$ sinking 1mA, the typical power dissipation is V_{CC} x 450µA plus 0.4V x 1mA. Package theta J-A is about 150°C/W, so with V_{CC} = 5V and no copper PC board heatsinking, the resulting temperature rise is:

 $dT = 2.7 \text{mW} \times 150^{\circ} \text{C/W} = 0.4^{\circ} \text{C}$

Even with these contrived circumstances, it is difficult to introduce significant self-heating errors.

ADC Noise Filtering

The ADC is an integrating type with inherently good noise rejection, especially of low-frequency signals such as 60Hz/120Hz power-supply hum. Micropower operation places constraints on high-frequency noise rejection; therefore, careful PC board layout and proper external noise filtering are required for high-accuracy remote measurements in electrically noisy environments.

High-frequency EMI is best filtered at DXP and DXN with an external 2200pF capacitor. This value can be increased to about 3300pF (max), including cable capacitance. Higher capacitance than 3300pF introduces errors due to the rise time of the switched current source.

Nearly all noise sources tested cause the ADC measurements to be higher than the actual temperature, typically by +1°C to +10°C, depending on the frequency and amplitude (see *Typical Operating Characteristics*).

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PC Board Layout

- 1) Place the MAX1617A as close as practical to the remote diode. In a noisy environment, such as a computer motherboard, this distance can be 4 in. to 8 in. (typical) or more as long as the worst noise sources (such as CRTs, clock generators, memory buses, and ISA/PCI buses) are avoided.
- Do not route the DXP-DXN lines next to the deflection coils of a CRT. Also, do not route the traces across a fast memory bus, which can easily introduce +30°C error, even with good filtering. Otherwise, most noise sources are fairly benign.
- Route the DXP and DXN traces in parallel and in close proximity to each other, away from any highvoltage traces such as +12V_{DC}. Leakage currents from PC board contamination must be dealt with carefully, since a $20M\Omega$ leakage path from DXP to ground causes about +1°C error.
- Connect guard traces to GND on either side of the DXP-DXN traces (Figure 2). With guard traces in place, routing near high-voltage traces is no longer an issue.
- Route through as few vias and crossunders as possible to minimize copper/solder thermocouple effects.
- 6) When introducing a thermocouple, make sure that both the DXP and the DXN paths have matching thermocouples. In general, PC board-induced thermocouples are not a serious problem. A copper-solder thermocouple exhibits 3µV/°C, and it takes about 200µV of voltage error at DXP-DXN to cause a +1°C measurement error. So, most parasitic thermocouple errors are swamped out.
- Use wide traces. Narrow ones are more inductive and tend to pick up radiated noise. The 10 mil widths and spacings recommended in Figure 2 aren't absolutely necessary (as they offer only a minor improvement in leakage and noise), but try to use them where practical.
- Keep in mind that copper can't be used as an EMI shield, and only ferrous materials, such as steel, work well. Placing a copper ground plane between the DXP-DXN traces and traces carrying high-frequency noise signals does not help reduce EMI.

PC Board Layout Checklist

- Place the MAX1617A close to a remote diode.
- Keep traces away from high voltages (+12V bus).
- Keep traces away from fast data buses and CRTs.
- Use recommended trace widths and spacings.
- Place a ground plane under the traces.

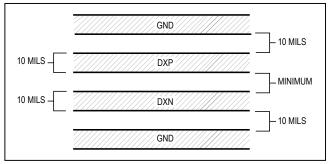


Figure 2. Recommended DXP/DXN PC Traces

- Use guard traces flanking DXP and DXN and connecting to GND.
- Place the noise filter and the 0.1µF V_{CC} bypass capacitors close to the MAX1617A.

Twisted Pair and Shielded Cables

For remote-sensor distances longer than 8 in., or in particularly noisy environments, a twisted pair is recommended. Its practical length is 6 feet to 12 feet (typical) before noise becomes a problem, as tested in a noisy electronics laboratory. For longer distances, the best solution is a shielded twisted pair like that used for audio microphones. For example, the Belden 8451 works well for distances up to 100 feet in a noisy environment. Connect the twisted pair to DXP and DXN and the shield to GND, and leave the shield's remote end unterminated.

Excess capacitance at DX_ limits practical remote sensor distances (see Typical Operating Characteristics). For very long cable runs, the cable's parasitic capacitance often provides noise filtering, so the 2200pF capacitor can often be removed or reduced in value.

Cable resistance also affects remote-sensor accuracy; 1Ω series resistance introduces about +1/2°C error.

Low-Power Standby Mode

Standby mode disables the ADC and reduces the supply- current drain to less than 10µA. Enter standby mode by forcing the STBY pin low or via the RUN/STOP bit in the configuration byte register. Hardware and software standby modes behave almost identically: all data is retained in memory, and the SMB interface is alive and listening for reads and writes. The only difference is that in hardware standby mode, the one-shot command does not initiate a conversion.

Standby mode is not a shutdown mode. With activity on the SMBus, extra supply current is drawn (see Typical Operating Characteristics). In software standby mode, the MAX1617A can be forced to perform A/D conversions

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through the one-shot command, despite the RUN/STOP bit being high.

Activate hardware standby mode by forcing the STBY pin low. In a notebook computer, this line may be connected to the system SUSTAT# suspend-state signal.

The STBY pin low state overrides any software conversion command. If a hardware or software standby command is received while a conversion is in progress, the conversion cycle is truncated, and the data from that conversion is not latched into either temperature reading register. The previous data is not changed and remains available.

Supply-current drain during the 125ms conversion period is always about 450µA. Slowing down the conversion rate reduces the average supply current (see Typical Operating Characteristics). Between conversions, the instantaneous supply current is about 25µA due to the current consumed by the conversion rate timer. In standby mode, supply current drops to about 3µA. At very low supply voltages (under the power-on-reset threshold), the supply current is higher due to the address pin bias currents. It can be as high as 100µA, depending on ADD0 and ADD1 settings.

SMBus Digital Interface

From a software perspective, the MAX1617A appears as a set of byte-wide registers that contain temperature data, alarm threshold values, or control bits. A standard SMBus 2-wire serial interface is used to read temperature data and write control bits and alarm threshold data. Each A/D channel within the device responds to the same SMBus slave address for normal reads and writes.

The MAX1617A employs four standard SMBus protocols: Write Byte, Read Byte, Send Byte, and Receive Byte (Figure 3). The shorter Receive Byte protocol allows quicker transfers, provided that the correct data register was previously selected by a Read Byte instruction. Use caution with the shorter protocols in multi-master systems, since a second master could overwrite the command byte without informing the first master.

The temperature data format is 7 bits plus sign in two's complement form for each channel, with each data bit representing 1°C (Table 2), transmitted MSB first. Measurements are offset by +1/2°C to minimize internal rounding errors; for example, +99.6°C is reported as +100°C.

5	S ADD	RESS	V	VR	ACK		CO	MMA	ND	ACK	D	ATA	ACK		Р	
	7	bits						8 bits			8	bits			1	
Slave Address: equivalent			С	omma	and E	Byte: se	ects which	Data	Byte: dat	a goes into	the regis	ster se				
	•			re	egister	you	are writi	ng to	by th	e comma	nd byte (to	set thre	sholds			
	3-wire	interfa	ce								confi	guration r	nasks, and	samplin	g rate	
Rea	d Byte For	mat														
S	ADDRESS	W	R AC	K CO	MMAN	ID A	ACK	S	A	DRESS	RD	ACK	DATA		Р	
	7 bits				8 bits					7 bits			8 bits			
	Slave Addre	ess:		Cor	nmand	Byte:	e: Slave Address:				3:	Data Byte: reads from				
	equivalent t	to		sele	ects wh	ich	repeated due to change					ge	the register set by the			
	chip-select line register you are			in data-flow direction comm												
	criip-select	IIIIE		regi	ister yo	u are			in c	ata-flow di	rection		command	byte		
	chip-select	IIIIC		_	ister yo ding fro				in c	ata-flow di	rection		command	byte		
Sen	d Byte For			_	-					ata-flow di ve Byte F			command	i byte		
	•		ACK	_	ding fro		Р		Receiv		ormat			III	P	
	d Byte For	mat	ACK	rea	ding fro	om	P		Receiv	ve Byte F	ormat				Р	
	d Byte For	mat	ACK	rea	ding fro	ACK			Receiv	ve Byte F	ormat	ACK	DATA	III	_	
	d Byte For	mat	ACK	COMM 8 bi	IAND ts	ACK	ds		Receiv	ve Byte F	ormat	Dai the	Byte: register c	/// ads dat	a fro	
	d Byte For	mat	ACK	COMM 8 bi Comma	IAND ts and Bytand with	ACK te: sen	ds		Receiv	ve Byte F	ormat	Date the	DATA 8 bits a Byte: re register c last Read	/// ads dat	a froi ded b	
	d Byte For	mat	ACK	COMM 8 bi Comma	IAND ts and Byte used for	ACK te: sen n no da or	ds		Receiv	ve Byte F	ormat	Dai the the Byt	DATA 8 bits a Byte: re register c last Read e transmiss	ads dat ommand Byte o sion; als	a fro ded k r Wri	
S	d Byte For	mat WR		COMM 8 bi Comma comma usually	ts and Byte used for comme	ACK te: sen n no da or mand	ds ata,		Receiv	ve Byte F	ormat	Date the Byte for	DATA 8 bits a Byte: re register c last Read	ads date ommand Byte osion; als	a froi ded b r Writ o use	

Figure 3. SMBus Protocols

Table 2. Data Format (Two's Complement)

TEMP.	ROUNDED TEMP.	DIC	GITAL OUTP DATA BITS	UT
(°C)	(°C)	SIGN	MSB	LSB
+130.00	+127	0	111	1111
+127.00	+127	0	111	1111
+126.50	+127	0	111	1111
+126.00	+126	0	111	1110
+25.25	+25	0	001	1001
+0.50	+1	0	000	0001
+0.25	0	0	000	0000
0.00	0	0	000	0000
-0.25	0	0	000	0000
-0.50	0	0	000	0000
-0.75	-1	1	111	1111
-1.00	-1	1	111	1111
-25.00	-25	1	110	0111
-25.50	-26	1	110	0110
-54.75	-55	1	100	1001
-55.00	-55	1	100	1001
-65.00	-65	1	011	1111
-70.00	-65	1	011	1111

Alarm Threshold Registers

Four registers store alarm threshold data, with high-temperature (T_{HIGH}) and low-temperature (T_{LOW}) registers for each A/D channel. If either measured temperature equals or exceeds the corresponding alarm threshold value, an ALERT interrupt is asserted.

The power-on-reset (POR) state of both T_{HIGH} registers is full scale (0111 1111, or +127°C). The POR state of both T_{LOW} registers is 1100 1001 or -55°C.

Diode Fault Alarm

There is a continuity fault detector at DXP that detects whether the remote diode has an open-circuit condition. At the beginning of each conversion, the diode fault is checked, and the status byte is updated. This fault detector is a simple voltage detector; if DXP rises above $V_{\rm CC}$ - 1V (typical) due to the diode current source, a fault is detected. Note that the diode fault isn't checked until a conversion is initiated, so immediately after power-on reset the status byte indicates no fault is present, even if the diode path is broken.

If the remote channel is shorted (DXP to DXN or DXP to GND), the ADC reads 0000 0000 so as not to trip

Table 3. Read Format for Alert Response Address (0001100)

BIT	NAME	FUNCTION
7 (MSB)	ADD7	
6	ADD6	
5	ADD5	Provide the current MAX1617A
4	ADD4	slave address that was latched at POR (Table 8)
3	ADD3	T GIV (Table 6)
2	ADD2	
1	ADD1	
0 (LSB)	1	Logic 1

either the T_{HIGH} or T_{LOW} alarms at their POR settings. In applications that are never subjected to 0°C in normal operation, a 0000 0000 result can be checked to indicate a fault condition in which DXP is accidentally short circuited. Similarly, if DXP is short circuited to V_{CC} , the ADC reads +127°C for both remote and local channels, and the device alarms.

ALERT Interrupts

The $\overline{\text{ALERT}}$ interrupt output signal is latched and can only be cleared by reading the Alert Response address. Interrupts are generated in response to T_{HIGH} and T_{LOW} comparisons and when the remote diode is disconnected (for continuity fault detection). The interrupt does not halt automatic conversions; new temperature data continues to be available over the SMBus interface after $\overline{\text{ALERT}}$ is asserted. The interrupt output pin is open-drain so that devices can share a common interrupt line. The interrupt rate can never exceed the conversion rate.

The interface responds to the SMBus Alert Response address, an interrupt pointer return-address feature (see *Alert Response Address* section). Prior to taking corrective action, always check to ensure that an interrupt is valid by reading the current temperature.

Alert Response Address

The SMBus Alert Response interrupt pointer provides quick fault identification for simple slave devices that lack the complex, expensive logic needed to be a bus master. Upon receiving an ALERT interrupt signal, the host master can broadcast a Receive Byte transmission to the Alert Response slave address (0001 100). Then any slave device that generated an interrupt attempts to identify itself by putting its own address on the bus (Table 3).

Table 4. Command-Byte Bit Assignments

REGISTER	COMMAND	POR STATE	FUNCTION
RLTS	00h	0000 0000*	Read local temperature: returns latest temperature
RRTE	01h	0000 0000*	Read remote temperature: returns latest temperature
RSL	02h	N/A	Read status byte (flags, busy signal)
RCL	03h	0000 0000	Read configuration byte
RCRA	04h	0000 0000	Read conversion rate byte
RLHN	05h	0111 1111	Read local T _{HIGH} limit
RLLI	06h	1100 1001	Read local T _{LOW} limit
RRHI	07h	0111 1111	Read remote T _{HIGH} limit
RRLS	08h	1100 1001	Read remote T _{LOW} limit
WCA	09h	N/A	Write configuration byte
WCRW	0Ah	N/A	Write conversion rate byte
WLHO	0Bh	N/A	Write local T _{HIGH} limit
WLLM	0Ch	N/A	Write local T _{LOW} limit
WRHA	0Dh	N/A	Write remote T _{HIGH} limit
WRLN	0Eh	N/A	Write remote T _{LOW} limit
OSHT	0Fh	N/A	One-shot command (use send-byte format)
SPOR	FCh	N/A	Write software POR
MFGID	FEh	0100 1101	Read manufacturer ID code
DEVID	FFh	0000001	Read device ID code

^{*}If the device is in hardware standby mode at POR, both temperature registers read 0°C.

The Alert Response can activate several different slave devices simultaneously, similar to the I²C general call. If more than one slave attempts to respond, bus arbitration rules apply, and the device with the lower address code wins. The losing device does not generate an acknowledge and continues to hold the ALERT line low until serviced (implies that the host interrupt input is level-sensitive). Successful reading of the alert response address clears the interrupt latch.

Command Byte Functions

The 8-bit command byte register ($\underline{\text{Table 4}}$) is the master index that points to the various other registers within the MAX1617A. The register's POR state is 0000 0000, so that a Receive Byte transmission (a protocol that lacks the command byte) that occurs immediately after POR returns the current local temperature data.

The one-shot command immediately forces a new conversion cycle to begin. In software standby mode (RUN/STOP bit = high), a new conversion is begun, after which the device returns to standby mode. If a conversion is in progress when a one-shot command is received, the

command is ignored. If a one-shot command is received in auto-convert mode (RUN/STOP bit = low) between conversions, a new conversion begins, the conversion rate timer is reset, and the next automatic conversion takes place after a full delay elapses.

Configuration Byte Functions

The configuration byte register (<u>Table 5</u>) is used to mask (disable) interrupts and to put the device in software standby mode. The lower six bits are internally set to (XX1111), making them "don't care" bits. Write zeros to these bits. This register's contents can be read back over the serial interface.

Status Byte Functions

The status byte register (Table 6) indicates which (if any) temperature thresholds have been exceeded. This byte also indicates whether or not the ADC is converting and whether there is an open circuit in the remote diode DXP–DXN path. After POR, the normal state of all the flag bits is zero, assuming none of the alarm conditions are present. The status byte is cleared by any successful read of the status byte, unless the fault persists.

Table 5. Configuration-Byte Bit Assignments

BIT	NAME	POR STATE	FUNCTION
7 (MSB)	MASK	0	Masks all ALERT interrupts when high.
6	RUN/ STOP	0	Standby mode control bit. If high, the device immediately stops converting and enters standby mode. If low, the device converts in either one-shot or timer mode.
5–0	RFU	0	Reserved for future use

Table 6. Status-Byte Bit Assignments

BIT	NAME	FUNCTION
7 (MSB)	BUSY	A high indicates that the ADC is busy converting.
6	LHIGH*	A high indicates that the local high-temperature alarm has activated.
5	LLOW*	A high indicates that the local low-temperature alarm has activated.
4	RHIGH*	A high indicates that the remote high-temperature alarm has activated.
3	RLOW*	A high indicates that the remote low-temperature alarm has activated.
2	OPEN*	A high indicates a remote-diode continuity (open-circuit) fault.
1	RFU	Reserved for future use (returns 0)
0 (LSB)	RFU	Reserved for future use (returns 0)

^{*}These flags stay high until cleared by POR, or until the status byte register is read.

Note that the $\overline{\text{ALERT}}$ interrupt latch is not automatically cleared when the status flag bit is cleared.

When auto-converting, if the T_{HIGH} and T_{LOW} limits are close together, it's possible for both high-temp and low-temp status bits to be set, depending on the amount of time between status read operations (especially when converting at the fastest rate). In these circumstances, it's best not to rely on the status bits to indicate reversals in long-term temperature changes and instead use a current temperature reading to establish the trend direction.

Table 7. Conversion-Rate Control Byte

DATA	CONVERSION RATE (Hz)	AVERAGE SUPPLY CURRENT (μA typ, at V _{CC} = 3.3V)
00h	0.0625	30
01h	0.125	33
02h	0.25	35
03h	0.5	48
04h	1	70
05h	2	128
06h	4	225
07h	8	425
08h to FFh	RFU	_

Conversion Rate Byte

The conversion rate register (Table 7) programs the time interval between conversions in free-running auto-convert mode. This variable rate control reduces the supply current in portable-equipment applications. The conversion rate byte's POR state is 02h (0.25Hz). The MAX1617A looks only at the 3 LSB bits of this register, so the upper 5 bits are "don't care" bits, which should be set to zero. The conversion rate tolerance is ±25% at any rate setting.

Valid A/D conversion results for both channels are available one total conversion time (125ms nominal, 156ms maximum) after initiating a conversion, whether conversion is initiated via the RUN/STOP bit, hardware STBY pin, one-shot command, or initial power-up. Changing the conversion rate can also affect the delay until new results are available (Table 8).

Manufacturer and Device ID Codes

Two ROM registers provide manufacturer and device ID codes (<u>Table 4</u>). Reading the manufacturer ID returns 4Dh, which is the ASCII code "M" (for Maxim). Reading the device ID returns 01h, indicating a MAX1617A device. If READ WORD 16-bit SMBus protocol is employed (rather than the 8-bit READ BYTE), the least significant byte contains the data and the most significant byte contains 00h in both cases.

Slave Addresses

The MAX1617A appears to the SMBus as one device having a common address for both ADC channels. The device address can be set to one of nine different values by pin-strapping ADD0 and ADD1 so that more than one MAX1617A can reside on the same bus without address conflicts (Table 9).

Table 8. RLTS and RRTE Temp Register Update Timing Chart

OPERATING MODE	CONVERSION INITIATED BY:	NEW CONVERSION RATE (CHANGED VIA WRITE TO WCRW)	TIME UNTIL RLTS AND RRTE ARE UPDATED
Auto-Convert	Power-on reset	n/a (0.25Hz)	156ms max
Auto-Convert	1-shot command, while idling between automatic conversions	n/a	156ms max
Auto-Convert	1-shot command that occurs during a conversion	n/a	When current conversion is complete (1-shot is ignored)
Auto-Convert	Rate timer	0.0625Hz	20sec
Auto-Convert	Rate timer	0.125Hz	10sec
Auto-Convert	Rate timer	0.25Hz	5sec
Auto-Convert	Rate timer	0.5Hz	2.5sec
Auto-Convert	Rate timer	1Hz	1.25sec
Auto-Convert	Rate timer	2Hz	625ms
Auto-Convert	Rate timer	4Hz	312.5ms
Auto-Convert	Rate timer	8Hz	237.5ms
Hardware Standby	STBY pin	n/a	156ms
Software Standby	RUN/STOP bit	n/a	156ms
Software Standby	1-shot command	n/a	156ms

The address pin states are checked at POR and SPOR only, and the address data stays latched to reduce quiescent supply current due to the bias current needed for high-Z state detection.

The MAX1617A also responds to the SMBus Alert Response slave address (see the *Alert Response Address* section).

POR and UVLO

The MAX1617A has a volatile memory. To prevent ambiguous power-supply conditions from corrupting the data in memory and causing erratic behavior, a POR voltage detector monitors V_{CC} and clears the memory if V_{CC} falls below 1.7V (typical, see <u>Electrical Characteristics</u> table). When power is first applied and V_{CC} rises above 1.75V (typical), the logic blocks begin operating, although reads and writes at V_{CC} levels below 3V are not recommended. A second V_{CC} comparator, the ADC UVLO comparator, prevents the ADC from converting until there is sufficient headroom (V_{CC} = 2.8V typical).

The SPOR software POR command can force a power-on reset of the MAX1617A registers via the serial interface. Use the SEND BYTE protocol with COMMAND = FCh. This is most commonly used to reconfigure the slave address of the MAX1617A "on the fly," where external hardware has forced new states at the ADD0 and ADD1 address pins prior to the software POR. The new address takes effect less than 100µs after the SPOR transmission stop condition.

Table 9. Slave Address Decoding (ADD0 and ADD1)

ADD0	ADD1	ADDRESS	
GND	GND	0011 000	
GND	High-Z	0011 001	
GND	V _{CC}	0011 010	
High-Z	GND	0101 001	
High-Z	High-Z	0101 010	
High-Z	V _{CC}	0101 011	
V _{CC}	GND	1001 100	
V _{CC}	High-Z	1001 101	
V _{CC}	V _{CC}	1001 110	

Note: High-Z means that the pin is left unconnected.

Power-Up Defaults:

- · Interrupt latch is cleared.
- Address select pins are sampled.
- ADC begins auto-converting at a 0.25Hz rate.
- Command byte is set to 00h to facilitate quick remote Receive Byte queries.
- T_{HIGH} and T_{LOW} registers are set to max and min limits, respectively.

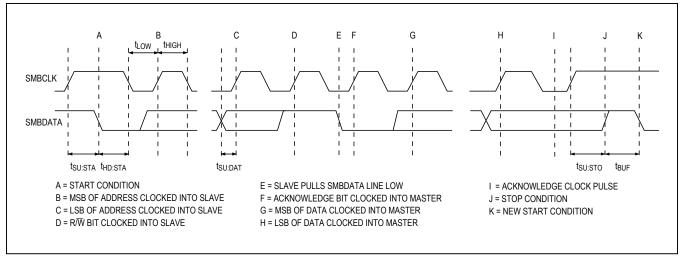


Figure 4. SMBus Write Timing Diagram

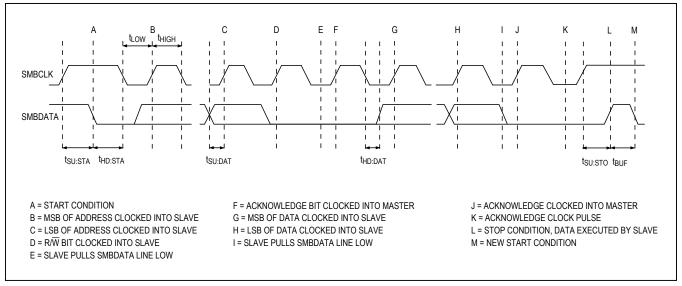


Figure 5. SMBus Read Timing Diagram

```
/* Beginning of the header file which sets the constants */
int
        NumStates
                       = 10;
int
        RRTE
                               /* 0x01, command for reading remote temp register */
                       = 1;
int
       WCA
                       = 9;
                               /* 0x09, command for writing configuration register */
                       = 10; /* 0x0A, command for writing conversion rate register */
       WCRW
int
int
       RSL
                       = 2;
                               /* 0x02, command for reading status register */
int
       WRHA
                       = 13;
                               /* 0x0D, command for writing remote THIGH limit register */
int
                      = 14;
       WRLN
                               /* 0x0E, command for writing remote TLOW limit register */
int NoError
                      = 0;
                     = 0;
int Nobody
int MAX1617Addr = 84; /* 0x54, default address for MAX1617, ADD0, ADD1=open */
                     = 0;
int InitConfig
                               /* 0x00, configure MAX1617 to MASK=0 and RUN/STOP=0 */
                               /* 0x07, conversion rate of 8Hz */
int
      InitConv
                       = 7;
int HighAdder = 2;
                              /* 2oC offset for calculating THIGH limit */
      LowSubtracter = 4;
int
                              /* 4oC offset for calculating TLOW limit */
       CollisionMask = 1;
                               /* 0x01, mask for status bit that indicates collision */
int
                               /* 0x04, mask for the OPEN diode fault status bit */
     DiodeFaultMask = 4;
int
       TempChangeMask = 24; /* 0x18, mask for RHIGH and RLOW status bits */
int
array State[0..NumStates] of int;
State[0] = -65 \text{ oC}
                       /* At or above this temperature CPU duty cycle is 100% */
State[1] = 72 oC
                       /* At or above this temperature CPU duty cycle is 87.5% */
                    /* At or above this temperature CPU duty cycle is 75% */
/* At or above this temperature CPU duty cycle is 62.5% */
/* At or above this temperature CPU duty cycle is 50% */
State[2] = 74 oC
State[3] = 76 \text{ oC}
State[4] = 78 \text{ oC}
State[5] = 80 oC
                     /* At or above this temperature CPU duty cycle is 37.5% */
State[6] = 82 oC
                     /* At or above this temperature CPU duty cycle is 25% */
                      /* At or above this temperature CPU duty cycle is 12.5% */
State[7] = 84 oC
State[8] = 86 oC /* At or above this temperature CPU duty cycle is 0 State[9] = 88 oC /* At or above this temperature SHUT SYSTEM OFF! */
                      /* At or above this temperature CPU duty cycle is 0.0% */
State[10] = 127 oC
                      /* Extra array location so looping is easier */
array ClockRate[0..NumStates] of real;
ClockRate[0] = 1.0;
ClockRate[1] = 0.875;
ClockRate[2] = 0.75;
ClockRate[3] = 0.625;
ClockRate[4] = 0.5;
ClockRate[5]
               = 0.375;
ClockRate[6]
               = 0.25;
ClockRate[7]
               = 0.125;
ClockRate[8]
ClockRate[9]
ClockRate[10] = 0;
/* End of the header file */
```

Listing 1. Pseudocode Example

```
int Initialization()
       int ErrorCode = NoError;
/* Test the SMBus communications path to the MAX1617 by writing the configuration,
conversion rate and initial temperature limits; if SMBus communication was unsuccessful,
power the system down. Note that the MAX1617Write procedure takes three parameters: the
command code of the register to be written, the data to write, and a pointer to the the
error code variable. If the error code variable does not equal NoError before the
execution of MAX1617Write, MAX1617Write does nothing. If the SMBus communication fails in
MAX1617Write, the error code variable is set to the type of error (for example a NACK,
i.e. MAX1617 did not acknowledge). This code assumes that the BIOS is already in thermal
state 0 (not throttling, i.e. full CPU clock rate) when the initialization routine is
executed. */
       MAX1617Write(WCA, InitConfig, &ErrorCode);
                                                      /* MASK=0 and RUN/STOP=0 */
       MAX1617Write(WCRW, InitConv, &ErrorCode);
                                                      /* CONV = 8Hz */
       MAX1617Write(WCRW, InitConv, &ErrorCode); /* CONV = 8Hz */
MAX1617Write(WRLN, LowestTemp, &ErrorCode); /* TLOW = -650C */
       MAX1617Write(WRHA, State[0] + HighAdder, &ErrorCode) /* THIGH = 72oC */
       if (ErrorCode != NoError) then {
               /* Power off the system */
                       /* End of if (ErrorCode ... */
       return (ErrorCode);
/\star After changing the conversion rate to 8Hz, the MAX1617 temperature register will not
have valid (i.e. current temperature) data for 238 milliseconds. */
        /* End of Initialization routine */
```

Listing 1. Pseudocode Example (continued)

Programming Example: Clock-Throttling Control for CPUs

Listing 1 gives an untested example of pseudocode for proportional temperature control of Intel mobile CPUs via a power-management microcontroller. This program consists of two main parts: an initialization routine and an interrupt handler. The initialization routine checks for SMBus communications problems and sets up the MAX1617A configuration and conversion rate. The interrupt handler responds to ALERT signals by reading the current temperature and setting a CPU clock duty factor proportional to that temperature. The relationship between clock duty and temperature is fixed in a look-up table contained in the microcontroller code.

Note: Thermal management decisions should be made based on the latest temperature obtained from the MAX1617A rather than the value of the Status Byte. The MAX1617A responds very quickly to changes in its environment due to its sensitivity and its small thermal mass. High and low alarm conditions can exist in the Status Byte due to the MAX1617A correctly reporting environmental changes around it.

```
int ALERT IntHandler()
       int ErrorCode = NoError;
       int WhoDunnit = Nobody;
       int FoundState = 0;
       int StatusInfo = 0;
       int TempHigh;
       int TempLow;
/* This interrupt handler verifies that the MAX1617 is the source of the interrupt (and
also clears the interrupt) via the SMBus Alert Response address; checks the status byte to
ensure that a temperature change did indeed cause the interrupt; reads the remote
temperature; programs a corresponding clock-throttling duty cycle, and sets up new Thigh
and Tlow limits. */
       ReadAlertResponse(&WhoDunnit, &ErrorCode);
       if (WhoDunnit == MAX1617Addr) then {
               MAX1617Read(RSL, &StatusInfo, &ErrorCode);
               if (((StatusInfo & CollisionMask) != 0) and (ErrorCode == NoError)) then
                      MAX1617Read(RSL, &StatusInfo, &ErrorCode);
               if (StatusInfo & DiodeFaultMask) != 0) then {
                      /* Shut down system because thermal diode doesn't work */
               else if ((StatusInfo & TempChangeMask) != 0) then {
                      MAX1617Read(RRTE, &TempRead, &ErrorCode);
                      while ((TempRead >= State[FoundState + 1]) and
                             (FoundState < (NumStates - 1)) do FoundState++;
                      if (FoundState == (NumStates - 1)) then {
                              /* Ahhhhh!!! SHUT SYSTEM OFF!!!! */
                      else {
                              /* adjust clock duty cycle */
                              TempHigh = TempRead + HighAdder;
                              TempLow = TempRead - LowSubtracter;
                              MAX1617Write(WRHA, TempHigh, &Error);
                              MAX1617Write(WRLN, TempLow, &Error);
                                     /* End of if (FoundState ... */
                      }
                              /* End of if (((StatusInfo .. else if ... */
               /* Handle local temp status bits if set */
       else
               /* Handle cases for other interrupt sources */
                      /* End of if (WhoDunnit ... */
       return(ErrorCode);
}
       /* End of Alert_IntHandler interrupt handler routine */
```

Listing 1. Pseudocode Example (continued)

Remote/Local Temperature Sensor with SMBus Serial Interface

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
16 QSOP	E116+1	<u>21-0055</u>	<u>90-0167</u>

Remote/Local Temperature Sensor with SMBus Serial Interface

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	1/99	Initial release	_
1	10/12	Updated Electrical Characteristics tables (added new Note 1); updated ADC and Multiplexer and Remote-Diode Selection sections	2–4, 6, 8
2	11/16	Removed 200Ω resistor from <i>Typical Operating Circuit</i> and references to the same throughout document	1, 6, 9

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